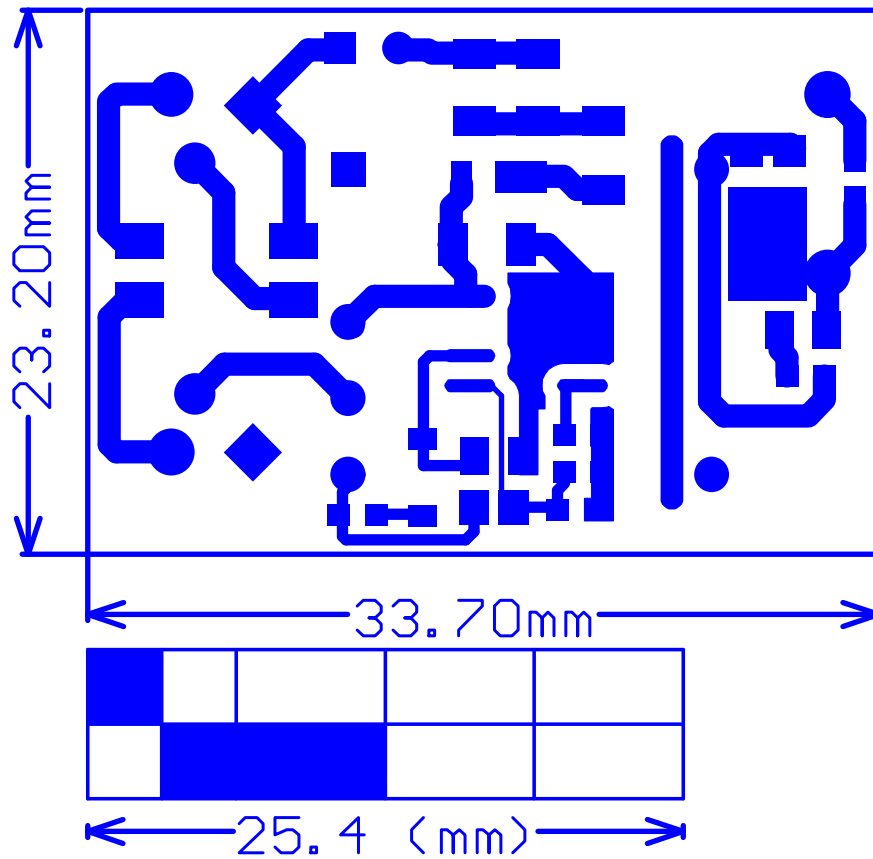


TIDC-WIFI-METER-READING

TIDC-WIFI-METER-READING
TIDC-WIFI-METER-READING

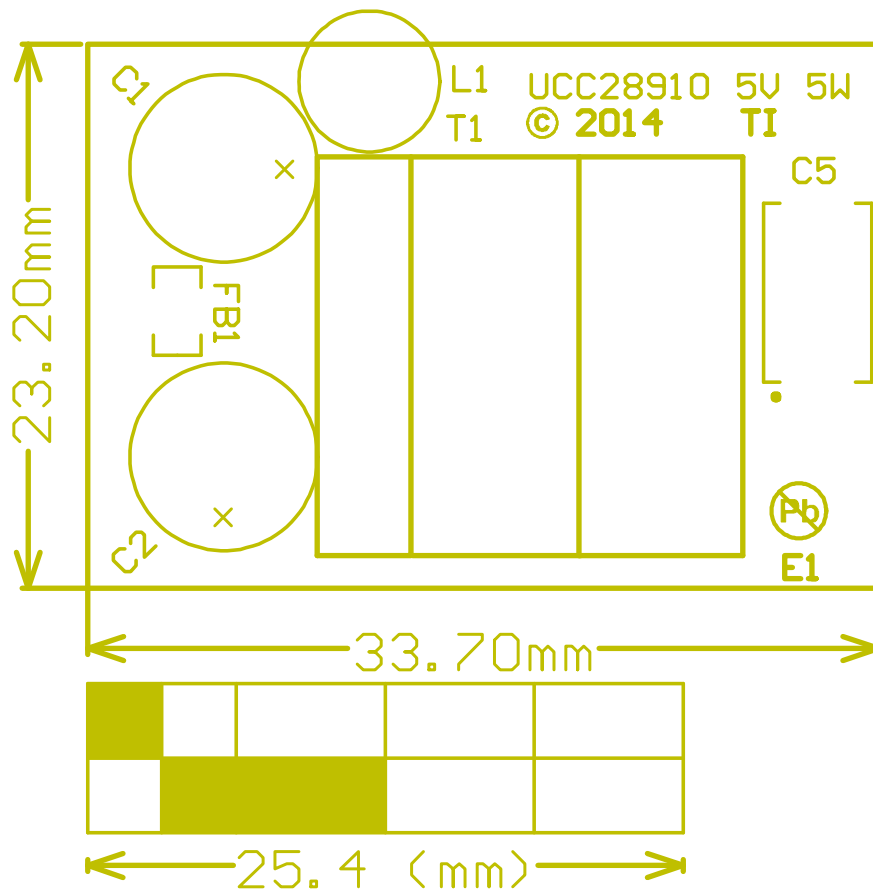
MapBoard Dimensions



TIDC-WIFI-METER-READING

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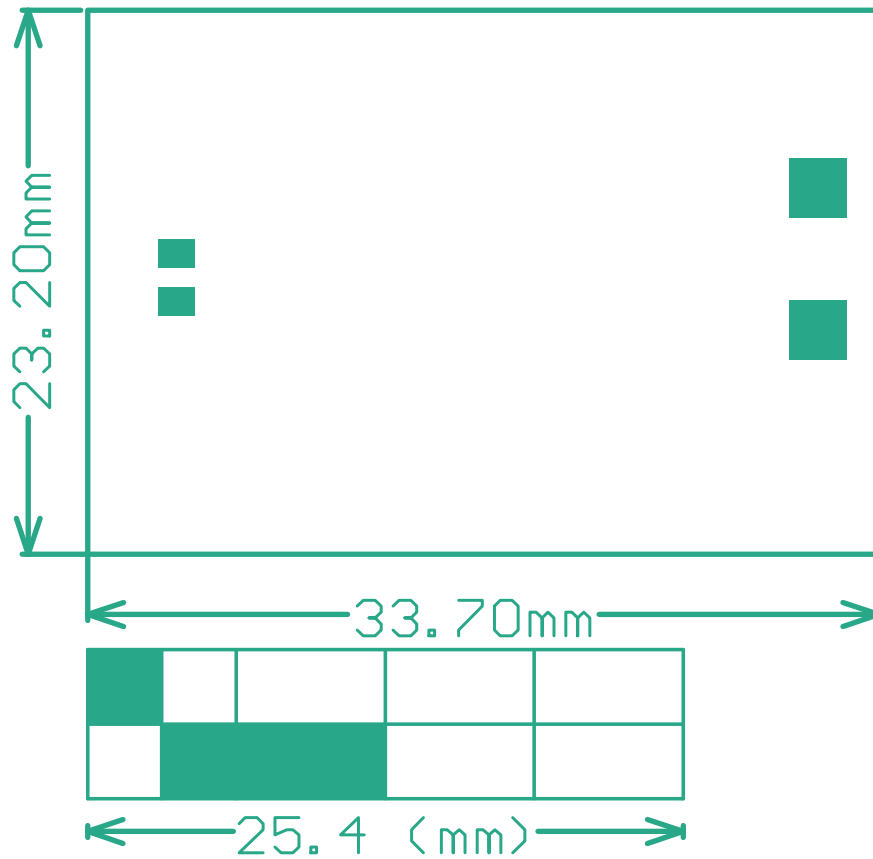
Bit Board Dimensions



TIDC-WIFI-METER-READING

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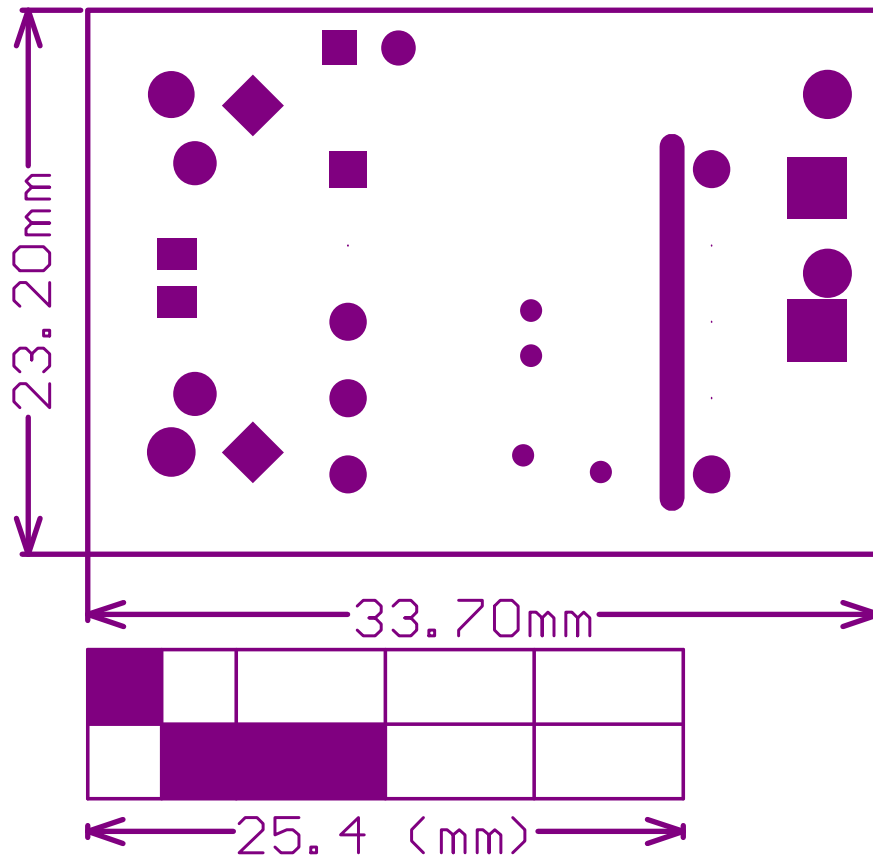
MapBoard1 Systems



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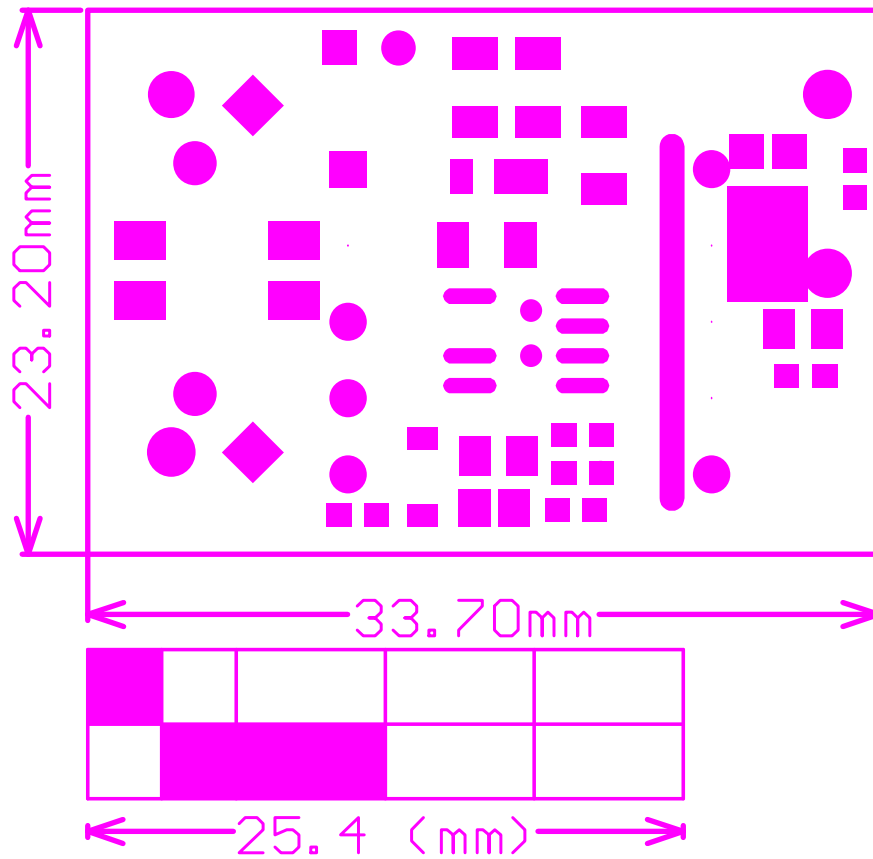
10pBoard Dimensions



TIDC-WIFI-METER-READING

TIDC-WIFI-METER-READING
TIDC-WIFI-METER-READING

Map Board de Dimensions

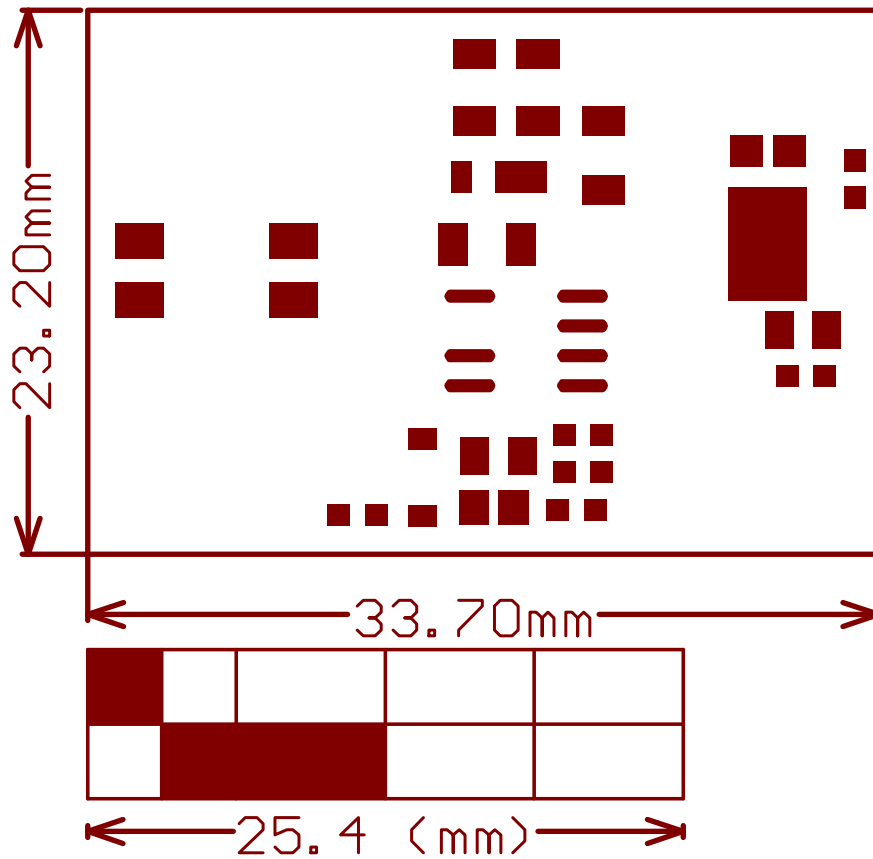


TIDC-WIFI-METER-READING

TIDC-WIFI-METER-READING

TIDC-WIFI-METER-READING

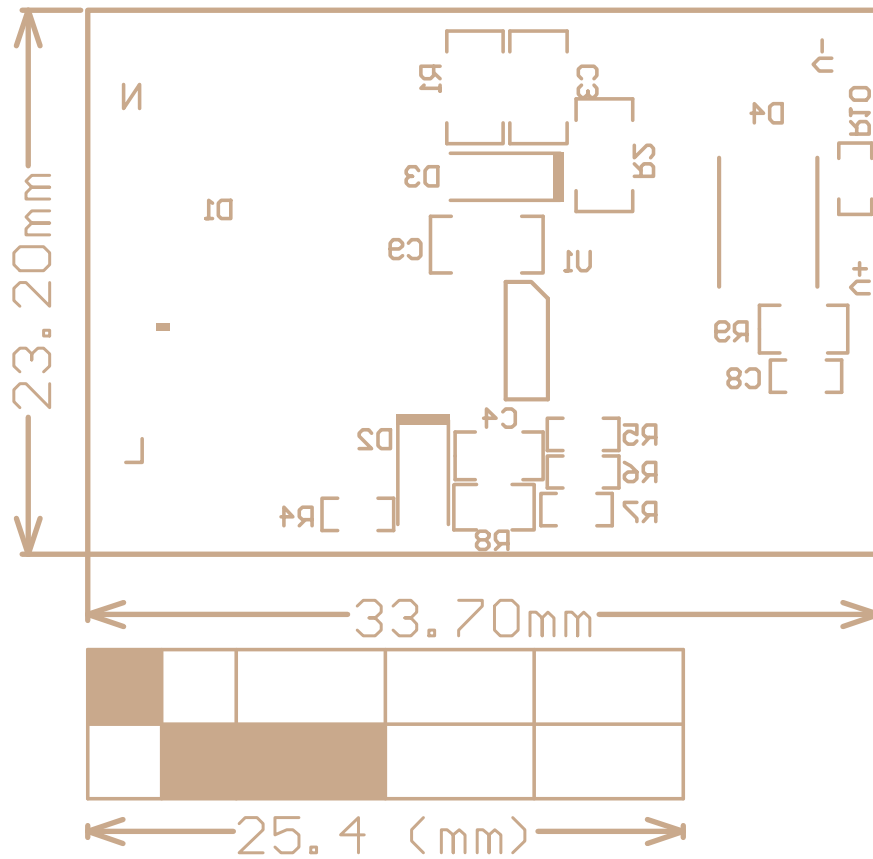
PCB Board Dimensions



TIDC-WIFI-METER-READING

TIDC-WIFI-METER-READING
TIDC-WIFI-METER-READING

Bit Board Dimensions



TIDC-WIFI-METER-READING
TIDC-WIFI-METER-READING
TIDC-WIFI-METER-READING

Get Board Dimensions

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